



RFM products are now Murata products.

SF2243A

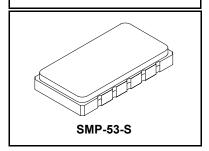
- · Low Insertion Loss
- Excellent Size-to-performance Ratio
- Hermetic 13.3 x 6.5 mm Surface-mount Case
- · Single-ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+18	dBm
Maximum DC Voltage on any Non-ground Terminal	10	VDC
Storage Temperature Range in Tape and Reel -40 to +85 °C		
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	





Electrical Specifications

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f _C			233.0		MHz
Maximum Insertion Loss	IL _{MAX}	1		11.0	12.0	dB
Passband Ripple, 231.0 to 235.0 MHz				0.6	1.0	dB _{P-P}
1 dB Bandwidth	BW ₁		4.0	5.3	-	MHz
3 dB Bandwidth	BW ₃	1, 2	-	6.0	-	MHz
45 dB Bandwidth	BW ₄₅		-	8.3	10.0	MHz
Rejection Referenced to IL _{MIN} :		1, 2, 3				
1 to 210 MHz			45	50		dB
246 to 400 MHz			45	50		1
Operating Temperature Range	T _A	1	-20		+70	°C
Frequency Temperature Coefficient				-23		ppm/°C
Wafer Material				LiTaO ₃		

Impedance Matching to 50 Ω Single-ended Source and Load	External L-C
Case Style	SMP-53-S 13.3 x 6.5 mm Nominal Footprint
Lid Symbolization (YY = year, WW = week)	SF2243A, YYWW

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

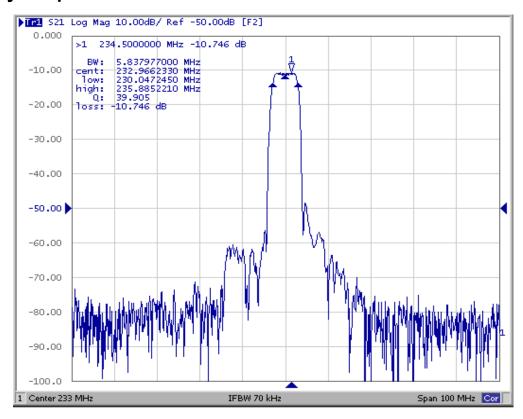
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- The turnover temperature, T_0 , is the temperature of maximum (or turnover) frequency, f_0 . The nominal frequency at any case temperature, T_c , may be calculated from: $f=f_0[1-FTC(T_0-T_c)^2]$.

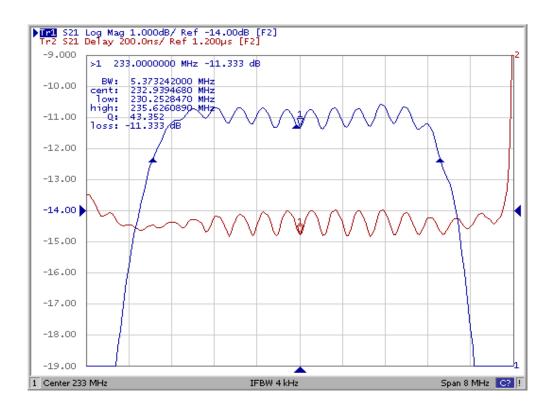
The design, manufacturing process, and specifications of this filter are subject to change.

Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.

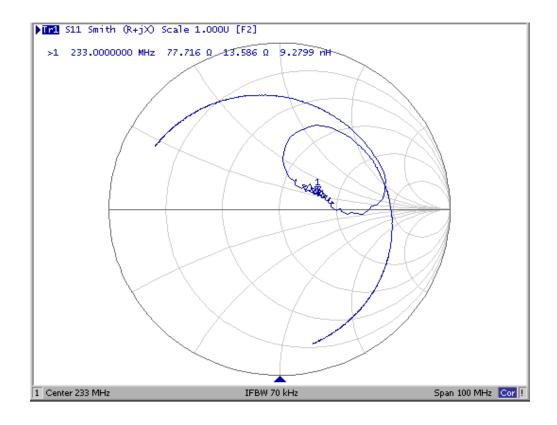
US and international patents may apply.

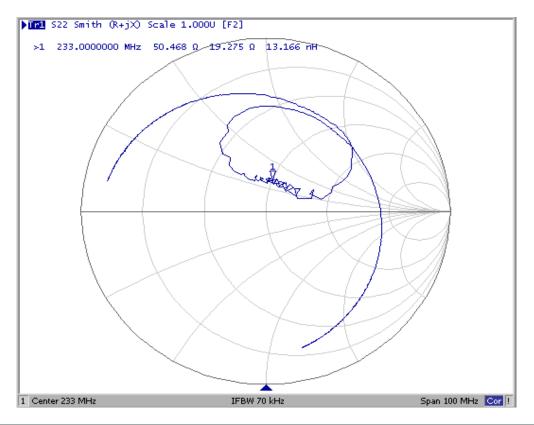
Frequency Respose Plots



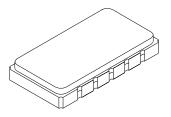


Input/Output Impedance Plots





SMP-53-S Ceramic Surface-mount 10-terminal Case 13.3 x 6.5 mm Nominal Footprint



Electrical Connections

Connection	Terminals		
Input	10		
Output	5		
Case Ground	All others		

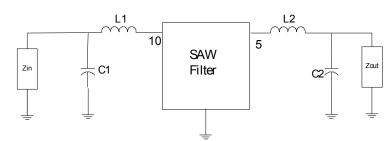
Case Dimensions

Dimension	mm		Inches			
Difficitsion	Min	Nom	Max	Min	Nom	Max
Α		13.3			.524	
В		6.5			.256	
С			2.00			.078
D		2.3			.091	
E		1.91			.075	
F		1.02			.040	
G		1.0			0.039	

Case Material

Materials					
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel				
Lid Plating	2.0 to 3.0 µm Nickel				
Body	Al ₂ O ₃ Ceramic				
Pb Free					

Typical Matching Network

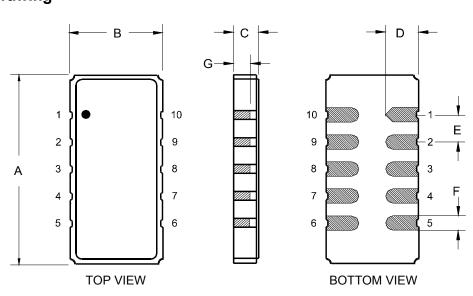


L1 = 27 nH, C1 = 18 pF, L2 = 33 nH, C2 = 20 pF

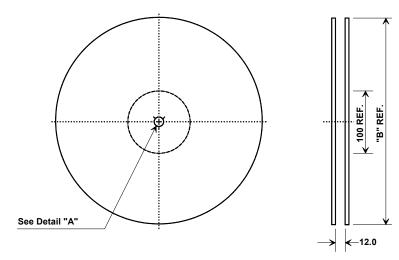
10.16

PCB Footprint (mm)

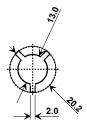
Case Outline Drawing



Reel Dimensions



"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



Tape Dimensions

